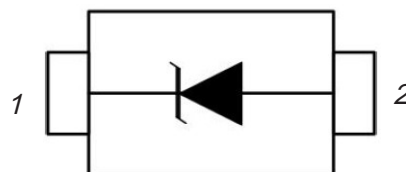


FEATURES

- IEC61000-4-2 (ESD) $\pm 15\text{kV}$ (air), $\pm 8\text{kV}$ (contact)
- IEC61000-4-4 (EFT) 40A (5/50ns)
- 350 Watts Peak Pulse Power per (tp=8/20μs)
- Protects one I/O line (unidirectional)
- Low clamping voltage
- Working voltages : 3.3V to 36V
- Low leakage current

**APPLICATIONS**

- Cell Phone Handsets and Accessories
- Microprocessor based equipment
- Personal Digital Assistants (PDA's)
- Notebooks, Desktops, and Servers
- Portable Instrumentation
- Networking and Telecom
- Serial and Parallel Ports
- Peripherals

MACHANICAL DATA

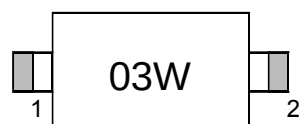
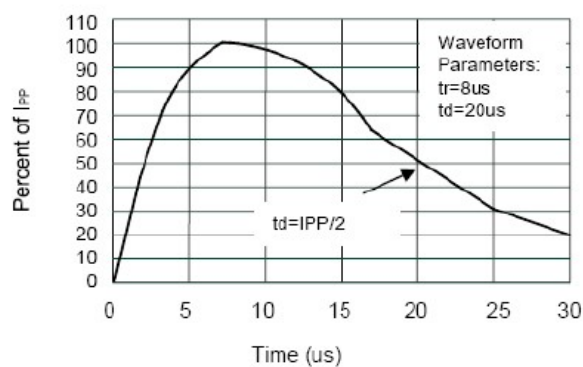
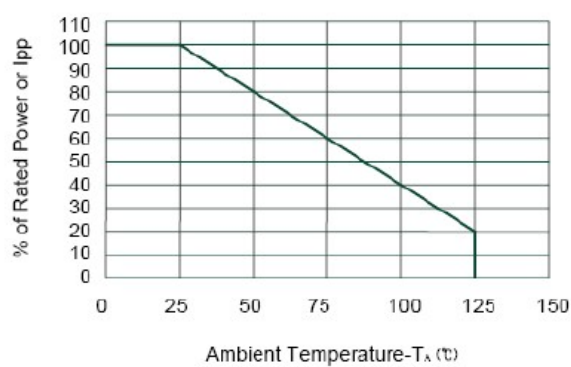
- SOD-323 package
- Packaging: Tape and Reel
- High temperature soldering guaranteed: 260°C/10s

ABSOLUTE MAXIMUM RATING

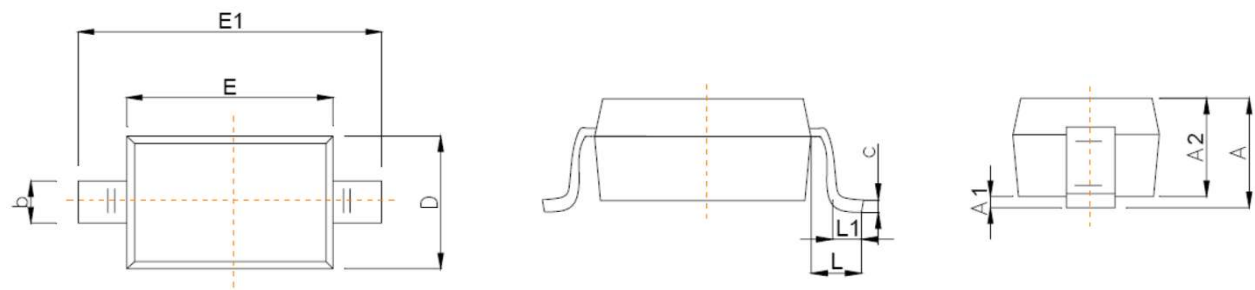
Symbol	Parameter	Value	Units
V_{ESD}	ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	± 15 ± 8	kV
P_{PP}	Peak Pulse Power (8/20μs)	350	W
T_{OPT}	Operating Temperature	-55/+150	°C
T_{STG}	Storage Temperature	-55/+150	°C
T_{L}	Lead Soldering Temperature	260 (10 sec.)	°C

ELECTRICAL CHARACTERISTICS (T_{amb}=25 °C)

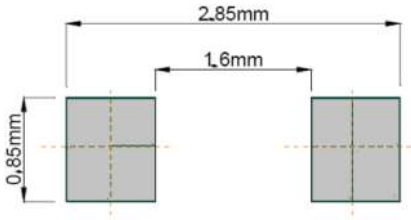
PART NUMBER	DEVICE MARKING	V _{RWM} (V) (max.)	V _B (V) (min.)	I _T (mA)	V _{C@1A} (V) (max.)	V _C (V) (max.) (@A)		I _R (μA) (max.)	C _T (pF) (max.)
SD03	03W	3.3	4	1	6.5	10.5	20	40	450
SD05	05W	5	6	1	9.8	18	17	10	300
SD12	12W	12	13.3	1	19	32	11	1	130
SD15	15W	15	16.7	1	24	38	10	1	120
SD18	18W	18	20.0	1	29	45	9	1	100
SD20	20W	20	22.3	1	35	50	8	1	90
SD24	24W	24	26.7	1	43	52	7	1	80
SD36	36W	36	40	1	60	75	5	1	60

Marking**ELECTRICAL CHARACTERISTICS CURVE****Pulse Waveform****Power Derating Curve**

SOD-323 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters	
	Min	Max
A		1.00
A1	0.000	0.100
A2	0.800	0.900
b	0.250	0.350
c	0.080	0.150
D	1.200	1.400
E	1.600	1.800
E1	2.500	2.700
e	1.800	2.040
L	0.475 REF	
L1	0.250	0.400
θ	0°	8°



Recommended Pad outline